

Description

The AP7365 is a 600mA, adjustable and fixed output voltage, low dropout linear regulator. The device included pass element, error amplifier, band-gap, current limit and thermal shutdown circuitry. The device is turned on when EN pin is set to logic high level.

The characteristics of low dropout voltage and low quiescent current make it suitable for low power applications, for example, battery powered devices. The typical quiescent current is approximately 35µA. Built-in current-limit and thermal-shutdown functions prevent IC from damage in fault conditions.

This device is available with adjustable output from 0.8V to 5.0V, and fixed version with 0.8V, 1.0V, 1.2V, 1.5V, 1.8V, 2.0V, 2.5V, 2.8V, 3.0V, 3.3V and 3.9V outputs. Please contact your local sales office for any other voltage options.

The AP7365 is available in SOT25, SOT89/R-3L, SOT223/R-3L, and DFN2020-6 packages.

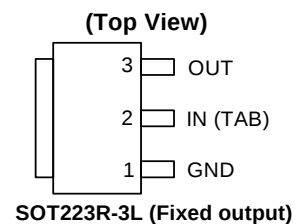
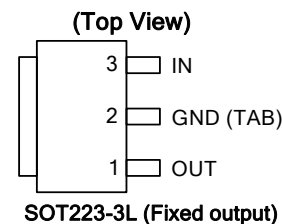
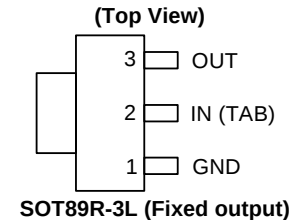
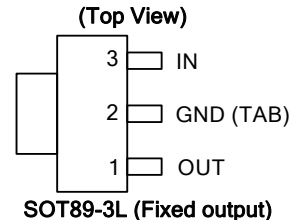
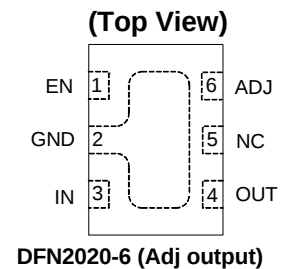
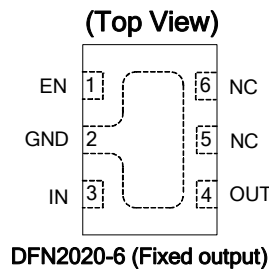
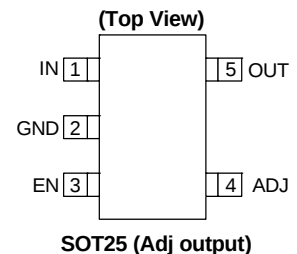
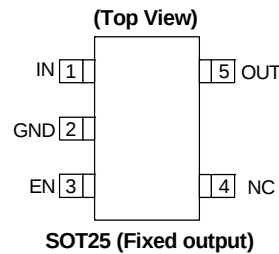
Features

- 600mA Low Dropout Regulator with EN
- Very low I_Q : 35µA
- Wide input voltage range: 2V to 6V
- Wide adjustable output: 0.8V to 5.0V
- Fixed output options: 0.8V to 3.9V (0.1V step size possible)
- High PSRR: 65dB at 1kHz
- Fast start-up time: 200µs
- Stable with low ESR, 1µF ceramic output capacitor
- Excellent Load/Line Transient Response
- Low dropout: 300mV at 600mA
- Current limit and short circuit protection
- Thermal shutdown protection
- Ambient temperature range: -40°C to 85°C
- SOT25, SOT89/R-3L, SOT223/R-3L, DFN2020-6: Available in "Green" Molding Compound (No Br, Sb)
- Lead Free Finish/ RoHS Compliant (Note 1)

Applications

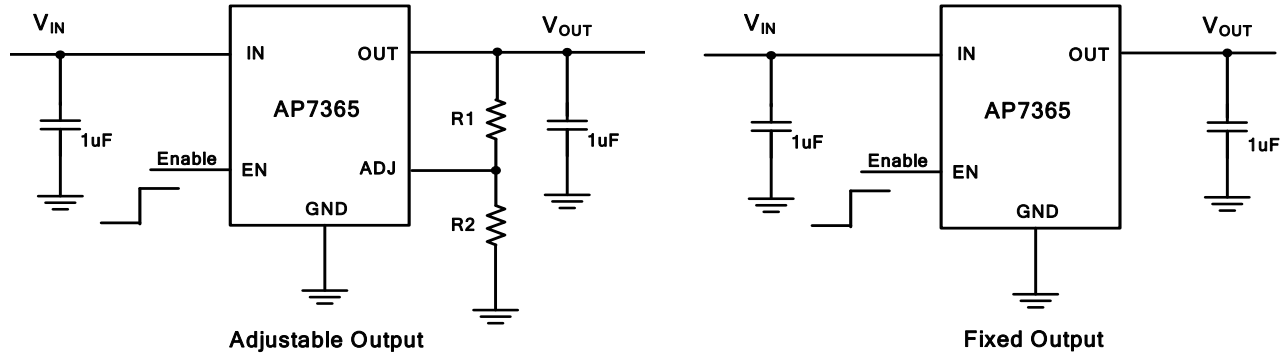
- Servers and notebook computers
- Low and medium power applications
- FPGA and DSP core or I/O power
- Consumer Electronics

Pin Assignments



Notes: 1. EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied. Please visit our website at http://www.diodes.com/products/lead_free.html.

Typical Application Circuit

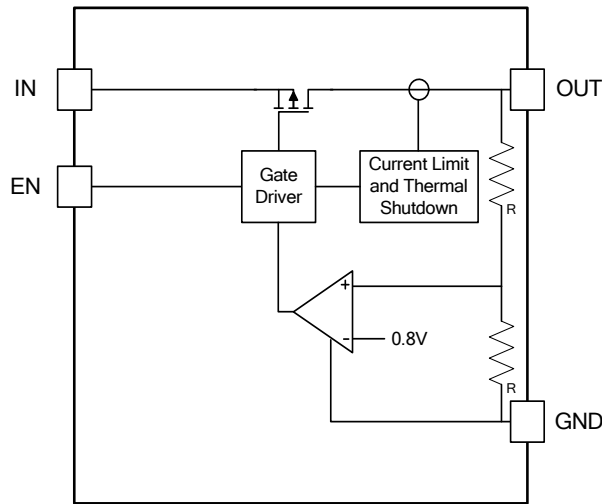


$$V_{OUT} = V_{REF} \left(1 + \frac{R_1}{R_2} \right) \text{ where } R_2 \leq 80K\Omega$$

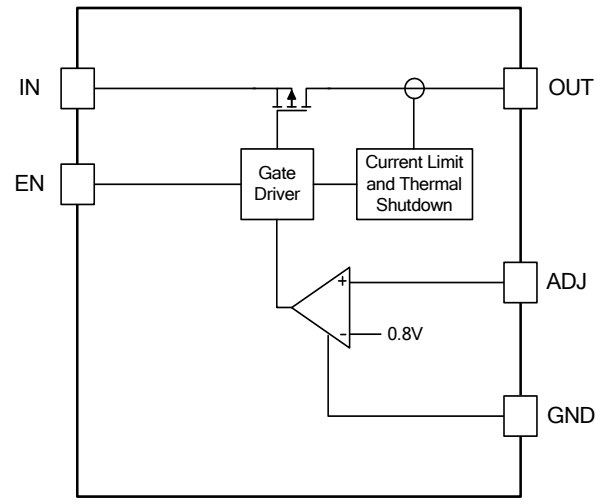
Pin Descriptions

Pin Name	Pin Number						Description
	SOT25 (fixed)	SOT25 (adj)	DFN2020-6 (fixed)	DFN2020-6 (adj)	SOT89/ SOT223	SOT89R/ SOT223R	
IN	1	1	3	3	3	2	Voltage input pin. Bypass to ground through at least 1 μ F MLCC capacitor
GND	2	2	2	2	2	1	Ground
EN	3	3	1	1	-	-	Enable input, active high
ADJ	-	4	-	6	-	-	Output feedback pin
NC	4	-	5, 6	5	-	-	No connection
OUT	5	5	4	4	1	3	Voltage output pin. Bypass to ground through 1 μ F MLCC capacitor

Functional Block Diagram



Fixed Version



Adjustable Version

Absolute Maximum Ratings

Symbol	Parameter	Ratings	Unit
ESD HBM	Human Body Model ESD Protection	2000	V
ESD MM	Machine Model ESD Protection	200	V
V_{IN}	Input Voltage	6.5	V
	OUT, EN Voltage	$V_{IN} + 0.3$	V
	Continuous Load Current per Channel	Internal Limited	
T_{ST}	Storage Temperature Range	-65 to 150	°C
T_J	Maximum Junction Temperature	150	°C

Recommended Operating Conditions

Symbol	Parameter	Min	Max	Unit
V_{IN}	Input voltage	2	6	V
I_{OUT}	Output Current (Note 2)	0	600	mA
T_A	Operating Ambient Temperature	-40	85	°C

Notes: 2 The device maintains a stable, regulated output voltage without a load current.

Electrical Characteristics

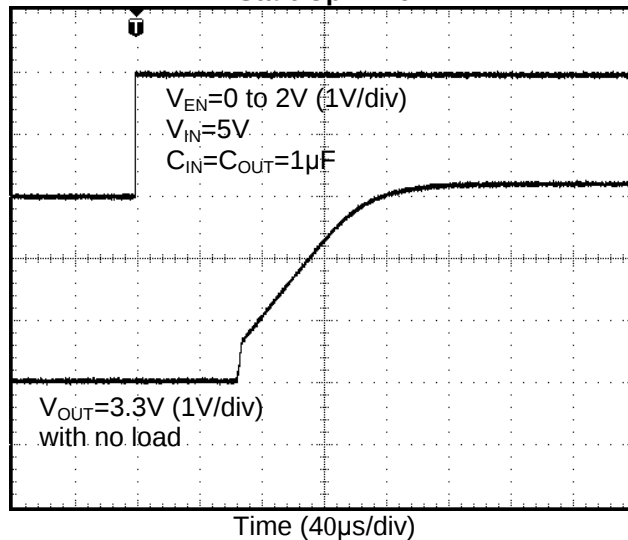
 (T_A = 25°C, V_{IN} = V_{OUT} + 1V, C_{IN} = 1μF, C_{OUT} = 1μF, V_{EN} = 2V, unless otherwise stated)

Symbol	Parameter	Test Conditions	Min	Typ.	Max	Unit
V _{REF}	ADJ Reference Voltage (Adjustable version)	I _{OUT} = 0mA		0.8		V
I _{ADJ}	ADJ Leakage (Adjustable version)			0.1	1	μA
V _{OUT}	Output Voltage Accuracy	T _A = -40°C to 85°C, I _{OUT} = 10% of I _{OUT-Max}	-2		2	%
ΔV _{OUT} / ΔV _{IN} / V	Line Regulation	V _{IN} = (V _{OUT} + 1V) to V _{IN-Max} , V _{EN} = V _{IN} , I _{OUT} = 1mA		0.02	0.20	%/V
ΔV _{OUT} / I _{OUT}	Load Regulation	V _{IN} = (V _{OUT} + 1V) to V _{IN-Max} , I _{OUT} = 1mA to 600mA	-1.0		1.0	%
V _{Dropout}	Dropout Voltage (Note 3)	V _{OUT} < 2.5V, I _{OUT} = 600mA		370	600	mV
		V _{OUT} ≥ 2.5V, I _{OUT} = 600mA		300	400	
I _Q	Input Quiescent Current	V _{EN} = V _{IN} , I _{OUT} = 0mA		35	80	μA
I _{SHDN}	Input Shutdown Current	V _{EN} = 0V, I _{OUT} = 0mA		0.1	1	μA
I _{LEAK}	Input Leakage Current	V _{EN} = 0V, OUT grounded		0.1	1	μA
t _{ST}	Start-up Time	V _{EN} = 0V to 2.0V in 1μs, I _{OUT} = 600mA		200		μs
PSRR	PSRR (Note 4)	V _{IN} = [V _{OUT} + 1V]V _{DC} + 0.5V _{ppAC} , f = 1kHz, I _{OUT} = 50mA		65		dB
I _{SHORT}	Short-circuit Current	V _{IN} = V _{IN-Min} to V _{IN-Max} , V _{OUT} < 0.2V (fixed version) or 25% of V _{OUT} (ADJ version)		240		mA
I _{LIMIT}	Current limit	V _{IN} = V _{IN-Min} to V _{IN-Max} , V _{OUT} /R _{OUT} = 2.5A	0.8	1.4		A
V _{IL}	EN Input Logic Low Voltage	V _{IN} = V _{IN-Min} to V _{IN-Max}			0.4	V
V _{IH}	EN Input Logic High Voltage	V _{IN} = V _{IN-Min} to V _{IN-Max}	1.4			V
I _{EN}	EN Input Current	V _{IN} = 0V or V _{IN-Max}	-1		1	μA
T _{SHDN}	Thermal shutdown threshold			145		°C
T _{HYS}	Thermal shutdown hysteresis			15		°C
θ _{JA}	Thermal Resistance Junction-to-Ambient	SOT25 (Note 5)		187		°C/W
		DFN2020-6 (Note 5)		251		
		SOT89-3L (Note 5)		141		
		SOT223-3L (Note 5)		153		

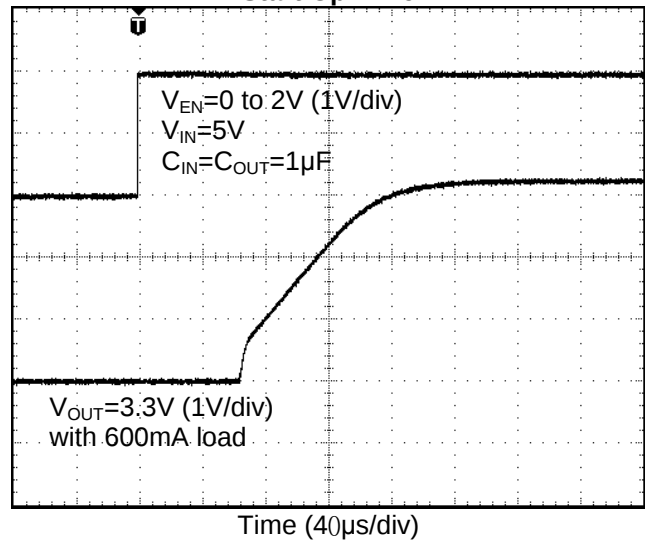
- Notes:
- Dropout voltage is the voltage difference between the input and the output at which the output voltage drops 2% below its nominal value. This parameter only applies to input voltages above minimum V_{IN} = 2.0V.
 - At V_{IN} < 2.3V, the PSRR performance may be reduced.
 - Test condition for all packages: Device mounted on FR-4 substrate PC board, 1oz copper, with minimum recommended pad layout.

Typical Performance Characteristics

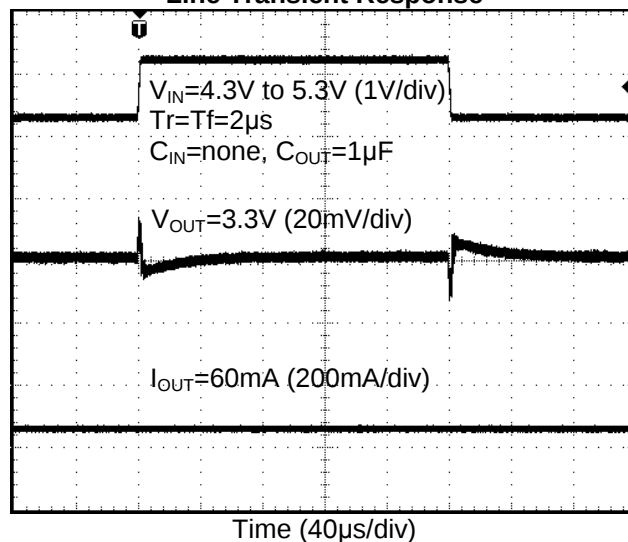
Start-Up Time



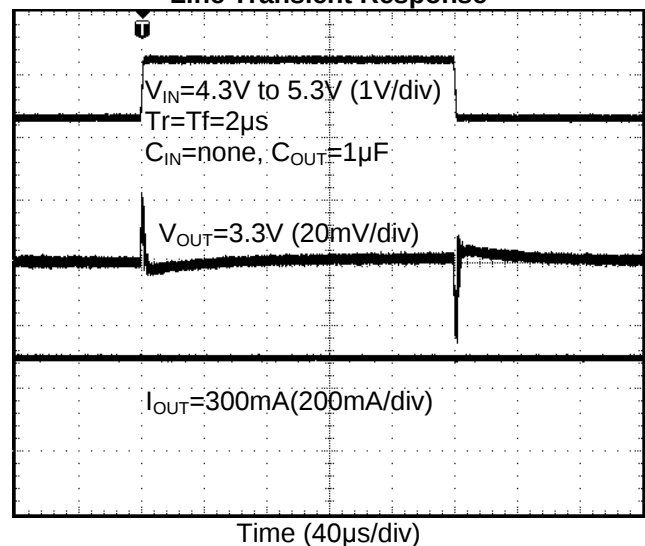
Start-Up Time



Line Transient Response

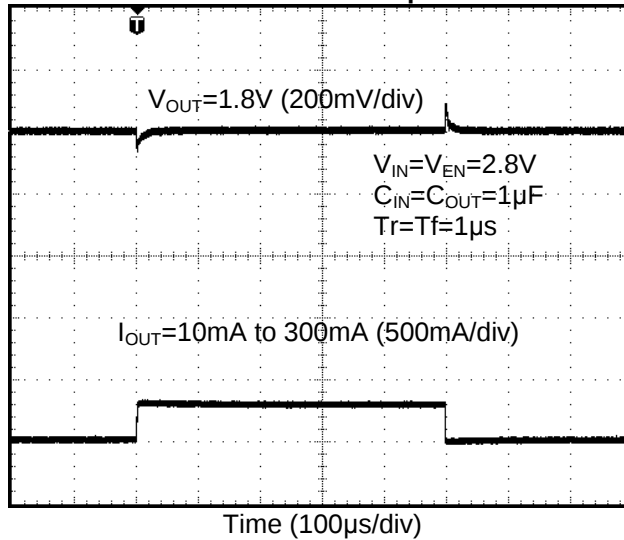


Line Transient Response

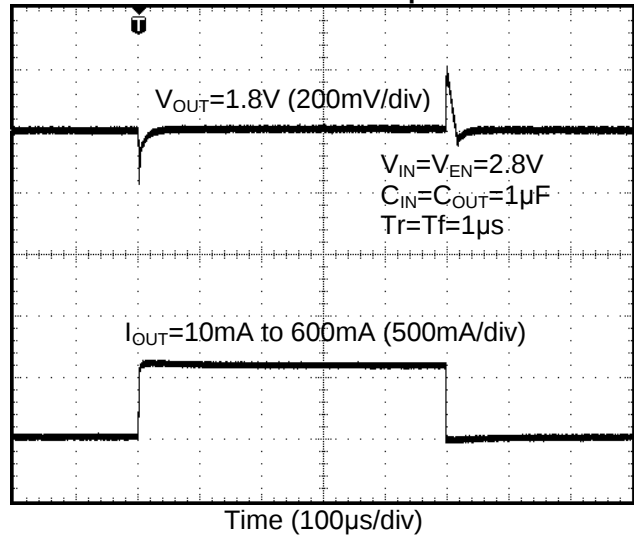


Typical Performance Characteristics (Continued)

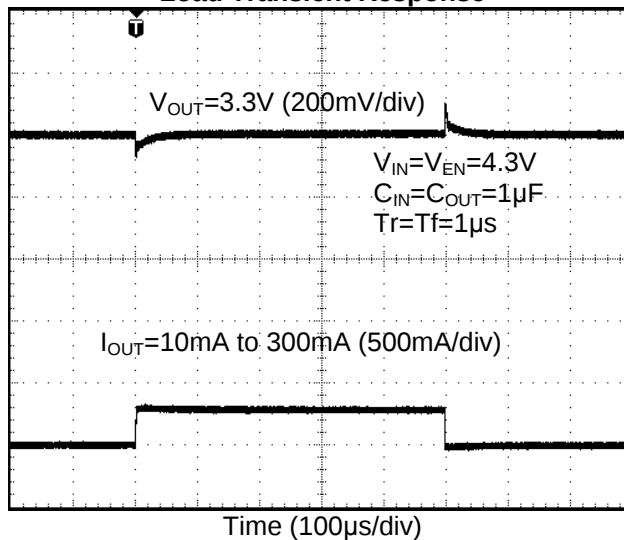
Load Transient Response



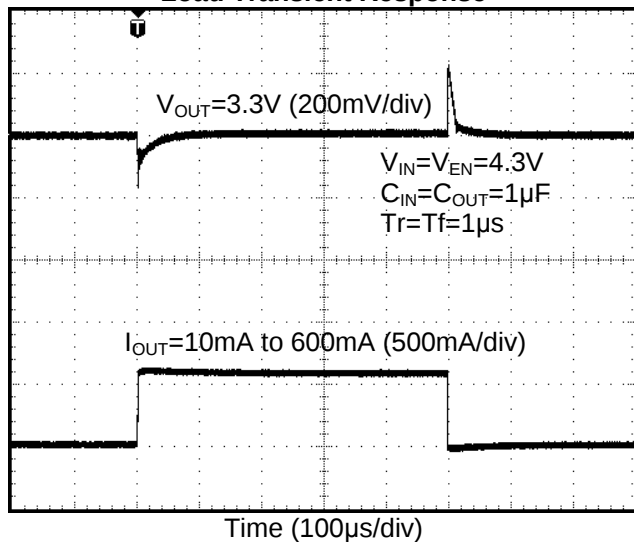
Load Transient Response



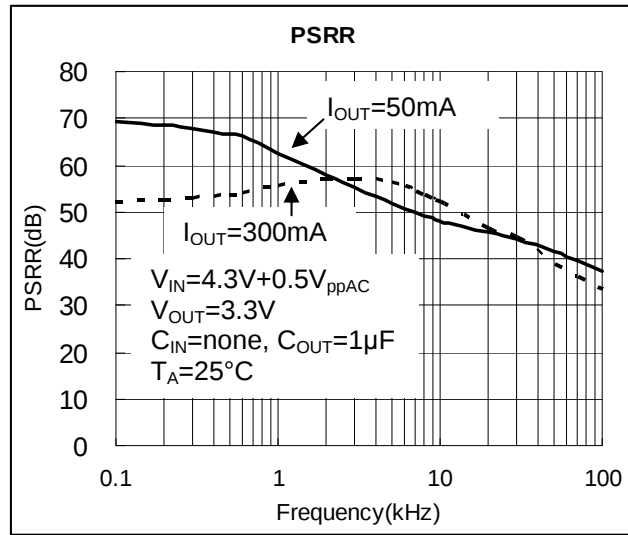
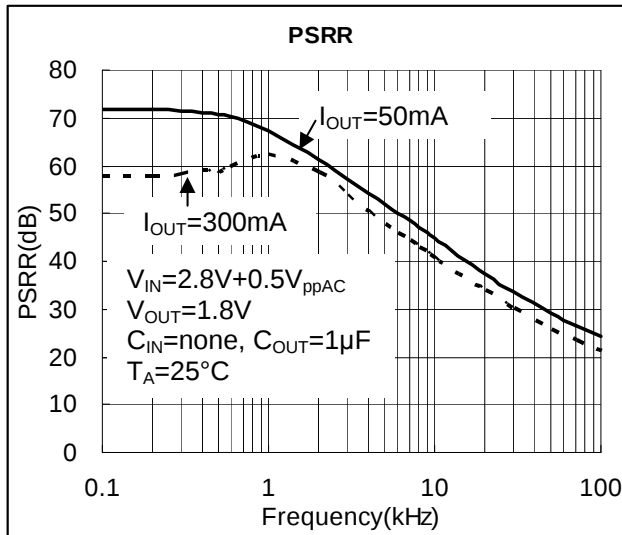
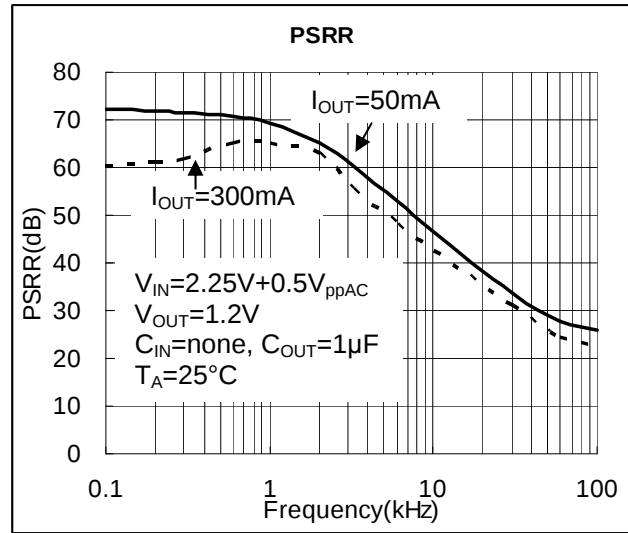
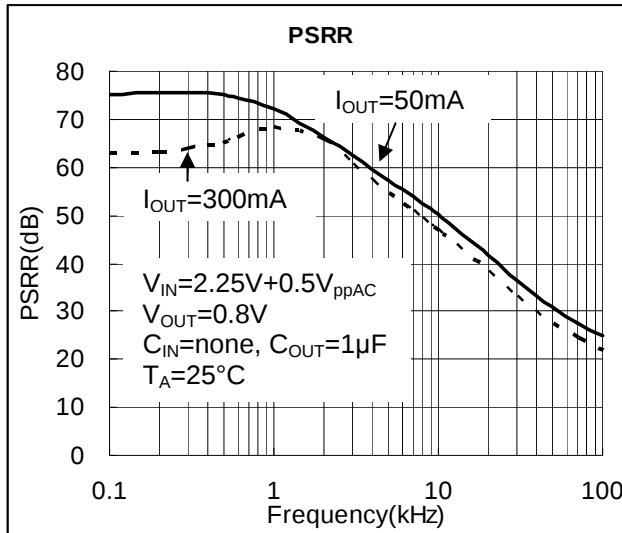
Load Transient Response



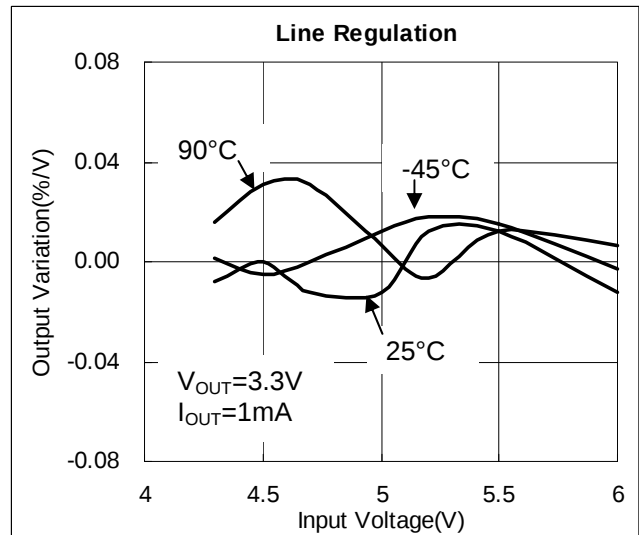
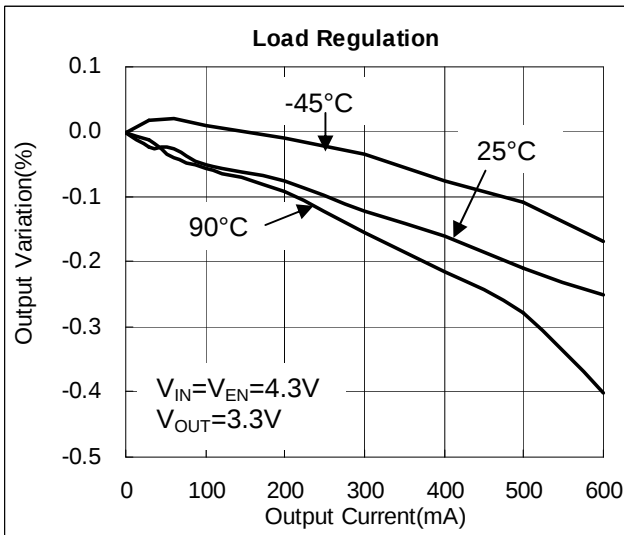
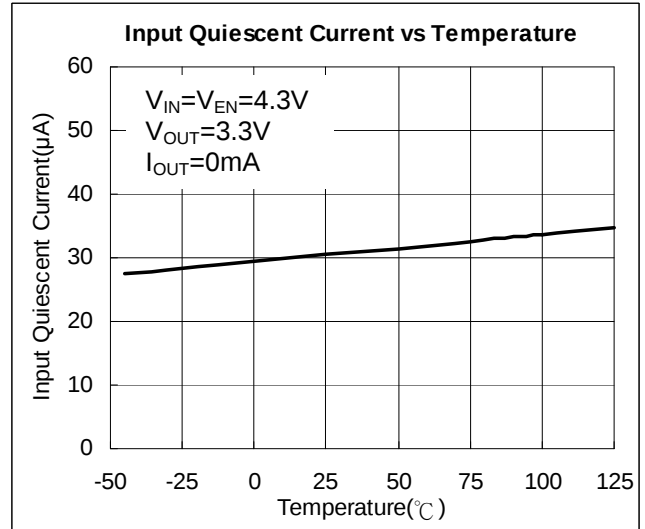
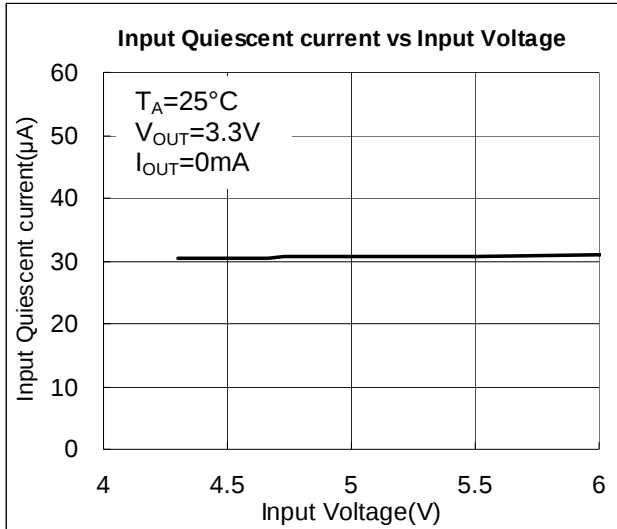
Load Transient Response



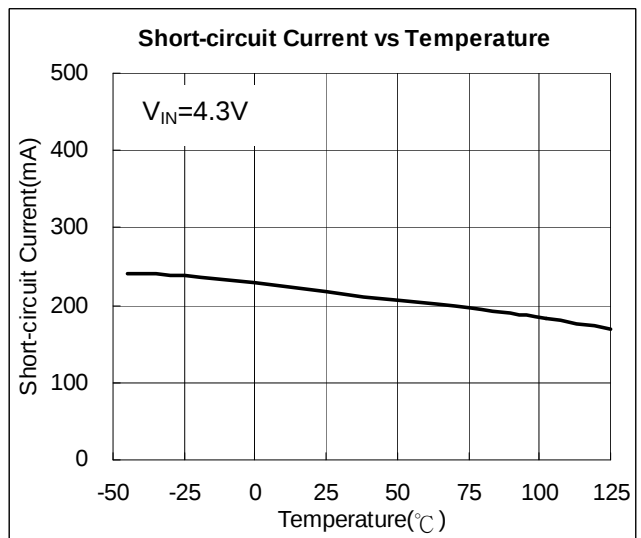
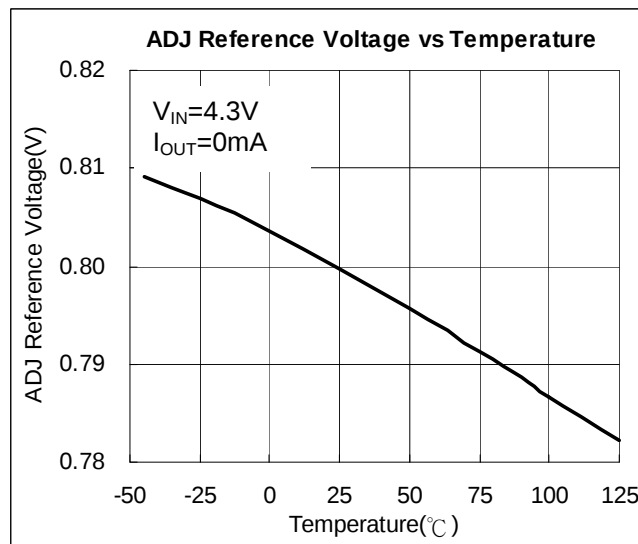
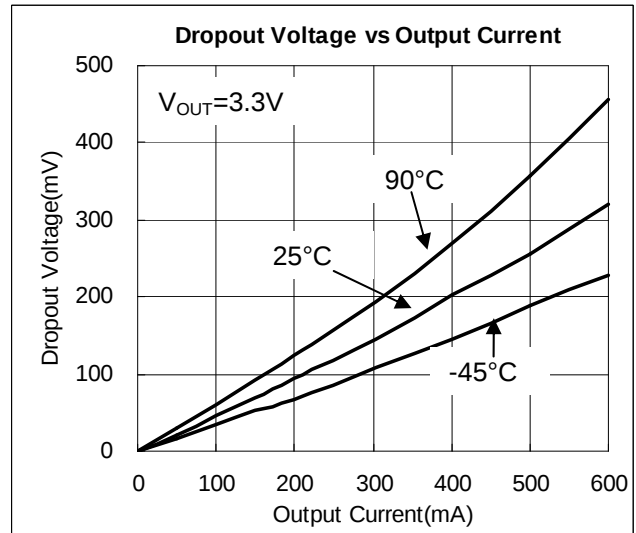
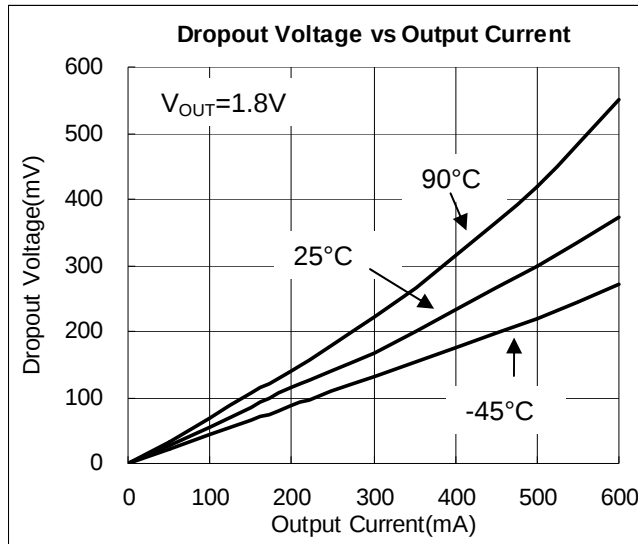
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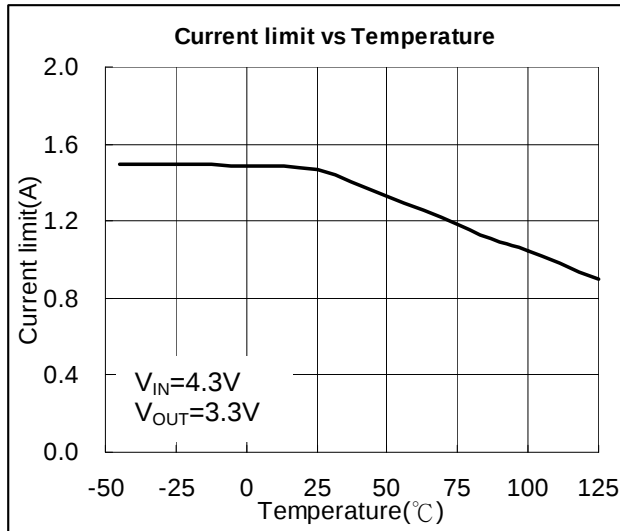
Typical Performance Characteristics (Continued)



Typical Performance Characteristics (Continued)



Typical Performance Characteristics (Continued)



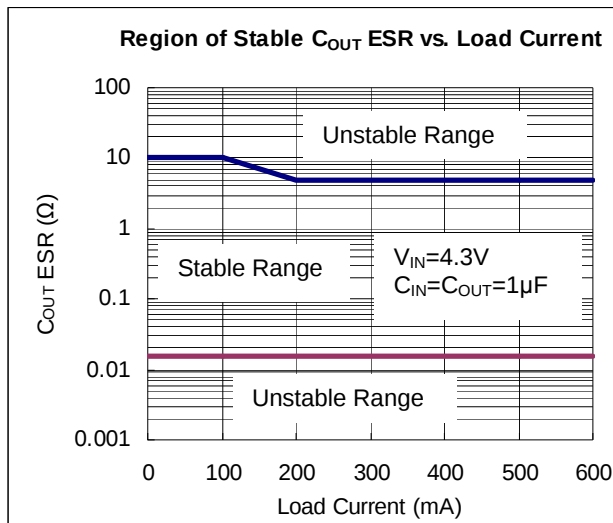
Application Note

Input Capacitor

A 1μF ceramic capacitor is recommended between IN and GND pins to decouple input power supply glitch and noise. The amount of the capacitance may be increased without limit. This input capacitor must be located as close as possible to the device to assure input stability and reduce noise. For PCB layout, a wide copper trace is required for both IN and GND pins. A lower ESR capacitor type allows the use of less capacitance, while higher ESR type requires more capacitance.

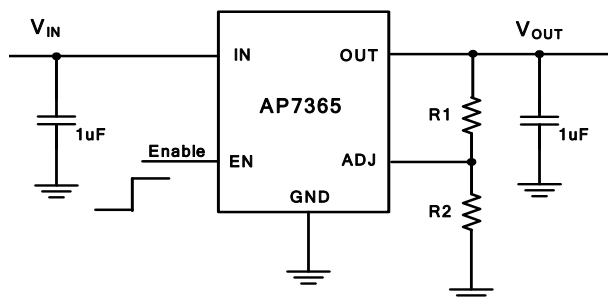
Output Capacitor

The output capacitor is required to stabilize and improve the transient response of the LDO. The AP7365 is stable with very small ceramic output capacitors. Using a ceramic capacitor value that is at least 1μF with ESR > 15mΩ on the output ensures stability. Higher capacitance values help to improve line and load transient response. The output capacitance may be increased to keep low undershoot and overshoot. Output capacitor must be placed as close as possible to OUT and GND pins.



Adjustable Operation

The AP7365 provides output voltage from 0.8V to 5.0V through external resistor divider as shown below.



The output voltage is calculated by:

$$V_{OUT} = V_{REF} \left(1 + \frac{R_1}{R_2} \right)$$

Where $V_{REF}=0.8V$ (the internal reference voltage)

Rearranging the equation will give the following that is used for adjusting the output to a particular voltage:

$$R_1 = R_2 \left(\frac{V_{OUT}}{V_{REF}} - 1 \right)$$

To maintain the stability of the internal reference voltage, R_2 need to be kept smaller than 80kΩ.

No Load Stability

Other than external resistor divider, no minimum load is required to keep the device stable. The device will remain stable and regulated in no load condition.

ON/OFF Input Operation

The AP7365 is turned on by setting the EN pin high, and is turned off by pulling it low. If this feature is not used, the EN pin should be tied to IN pin to keep the regulator output on at all time. To ensure proper operation, the signal source used to drive the EN pin must be able to swing above and below the specified turn-on/off voltage thresholds listed in the Electrical Characteristics section under V_{IL} and V_{IH} .

Current Limit Protection

When output current at OUT pin is higher than current limit threshold, the current limit protection will be triggered and clamp the output current to approximately 1.4A to prevent over-current and to protect the regulator from damage due to overheating.

Short Circuit Protection

When OUT pin is short-circuit to GND, short circuit protection will be triggered and clamp the output current to approximately 240mA. This feature protects the regulator from over-current and damage due to overheating.

Thermal Shutdown Protection

Thermal protection disables the output when the junction temperature rises to approximately +145°C, allowing the device to cool down. When the junction temperature reduces to approximately +130°C the output circuitry is enabled again. Depending on power dissipation, thermal resistance, and ambient temperature, the thermal protection circuit may cycle on and off. This cycling limits the heat dissipation of the regulator, protecting it from damage due to overheating.

Application Note (Continued)

Ultra Fast Start-up

After enabled, the AP7365 is able to provide full power in as little as hundreds of microseconds, typically 200μs, without sacrificing low ground current. This feature will help load circuitry move in and out of standby mode in real time, eventually extend battery life for mobile phones and other portable devices.

Fast Transient Response

Fast transient response LDO can extend battery life. TDMA-based cell phone protocols such as Global System for Mobile Communications (GSM) have a transmit/receive duty factor of only 12.5 percent, enabling power savings by putting much of the baseband circuitry into standby mode in between transmit cycles. In baseband circuits, the load often transitions virtually instantaneously from 100μA to 100mA. To meet this load requirement, the LDO must react very quickly without a large voltage drop or overshoot — a requirement that cannot be met with conventional, general-purpose LDO.

The AP7365's fast transient response from 0 to 600mA provides stable voltage supply for fast DSP and GSM chipset with fast changing load.

Low Quiescent Current

The AP7365, consuming only around 35μA for all input range, provides great power saving in portable and low power applications.

Wide Output Range

The AP7365, with a wide output range of 0.8V to 5.0V, provides a versatile LDO solution for many portable applications.

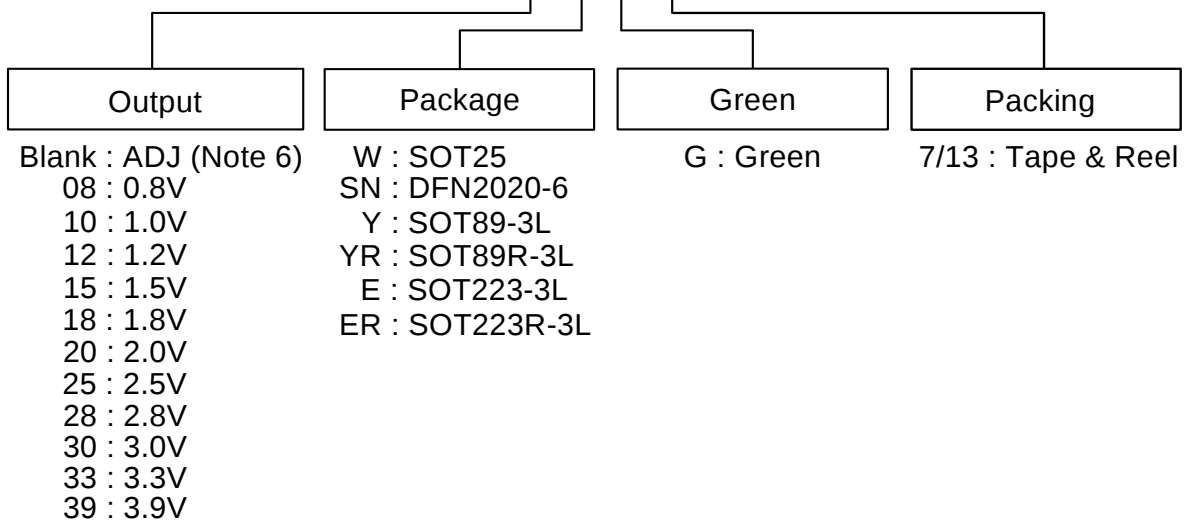
Power Dissipation

The device power dissipation and proper sizing of the thermal plane that is connected to the thermal pad is critical to avoid thermal shutdown and ensure reliable operation. Power dissipation of the device depends on input voltage and load conditions and can be calculated by:

$$P_D = (V_{IN} - V_{OUT}) \times I_{OUT}$$

The maximum power dissipation, handled by the device, depends on the maximum junction to ambient thermal resistance, maximum ambient temperature, and maximum device junction temperature, which can be calculated by the equation in the following:

$$P_D (\text{max}@T_A) = \frac{(+145^\circ\text{C} - T_A)}{R_{\theta JA}}$$

Ordering Information
AP7365 - XX XX G - X


Device	Package Code	Packaging (Note 7)	7"/13" Tape and Reel	
			Quantity	Part Number Suffix
AP7365-XXWG-7	W	SOT25	3000/Tape & Reel	-7
AP7365-XXSNG-7	SN	DFN2020-6	3000/Tape & Reel	-7
AP7365-XXYG-13	Y	SOT89-3L	2500/Tape & Reel	-13
AP7365-XXYRG-13	YR	SOT89R-3L	2500/Tape & Reel	-13
AP7365-XXEG-13	E	SOT223-3L	2500/Tape & Reel	-13
AP7365-XXERG-13	ER	SOT223R-3L	2500/Tape & Reel	-13

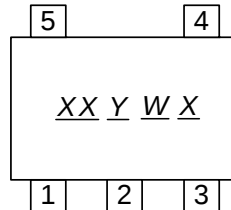
Notes: 6. Adjustable version is only available in SOT25 and DFN2020-6 package.

7. Pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which can be found on our website at <http://www.diodes.com/datasheets/ap02001.pdf>.

Marking Information

(1) SOT25

(Top View)



XX : Identification code

Y : Year 0~9

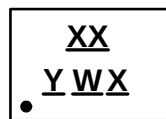
W : Week : A~Z : 1~26 week;
a~z : 27~52 week; z represents
52 and 53 week

X : A~Z : Green

Device	Package	Identification Code
AP7365-ADJ	SOT25	VA
AP7365-08	SOT25	VB
AP7365-10	SOT25	VC
AP7365-12	SOT25	VD
AP7365-15	SOT25	VE
AP7365-18	SOT25	VF
AP7365-20	SOT25	VG
AP7365-25	SOT25	VH
AP7365-28	SOT25	VJ
AP7365-30	SOT25	VK
AP7365-33	SOT25	VM
AP7365-39	SOT25	VN

(2) DFN2020-6

(Top View)



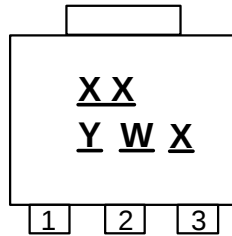
XX : Identification Code

Y : Year : 0~9

W : Week : A~Z : 1~26 week;
a~z : 27~52 week; z represents
52 and 53 week

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Device	Package	Identification Code
AP7365-ADJ	DFN2020-6	VA
AP7365-08	DFN2020-6	VB
AP7365-10	DFN2020-6	VC
AP7365-12	DFN2020-6	VD
AP7365-15	DFN2020-6	VE
AP7365-18	DFN2020-6	VF
AP7365-20	DFN2020-6	VG
AP7365-25	DFN2020-6	VH
AP7365-28	DFN2020-6	VJ
AP7365-30	DFN2020-6	VK
AP7365-33	DFN2020-6	VM
AP7365-39	DFN2020-6	VN

Marking Information (Continued)
(3) SOT89-3L and SOT89R-3L
(Top View)

XX : Identification code

Y : Year : 0~9

W : Week : A~Z : 1~26 week;

a~z : 27~52 week;

z represents 52 and 53 week

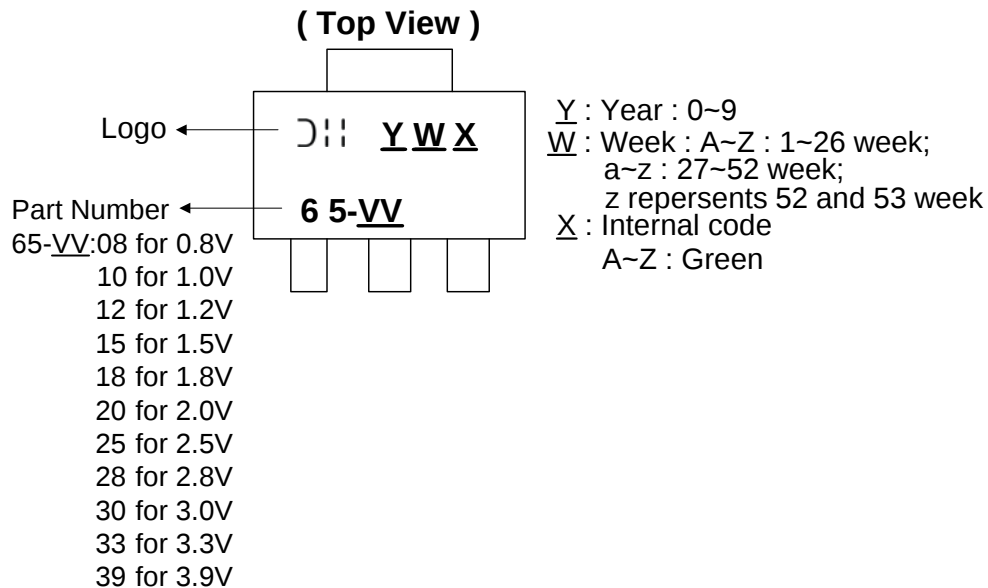
X : Internal code

A~Z : Green

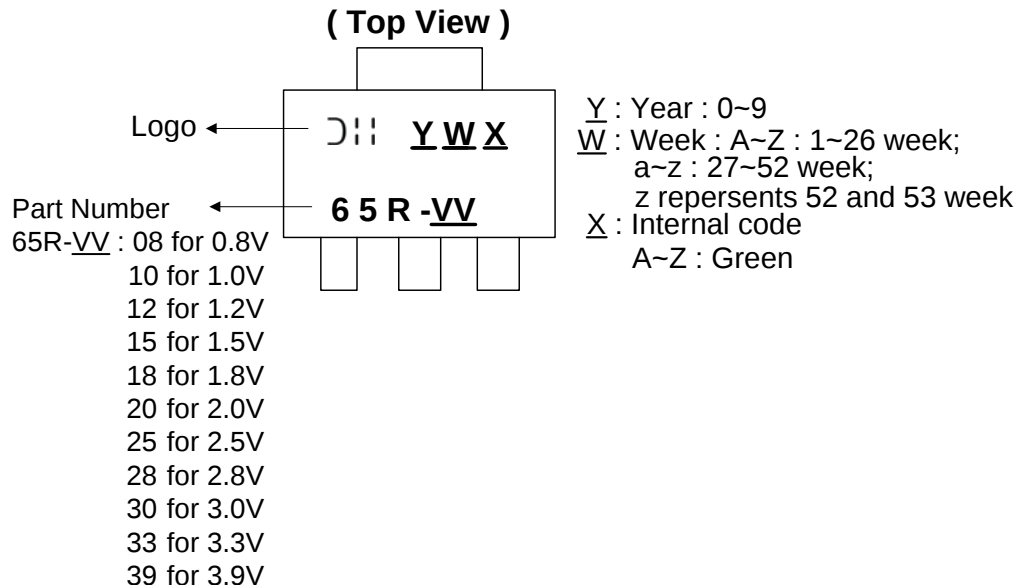
Device	Package	Identification Code
AP7365-08	SOT89-3L	VB
AP7365-10	SOT89-3L	VC
AP7365-12	SOT89-3L	VD
AP7365-15	SOT89-3L	VE
AP7365-18	SOT89-3L	VF
AP7365-20	SOT89-3L	VG
AP7365-25	SOT89-3L	VH
AP7365-28	SOT89-3L	VJ
AP7365-30	SOT89-3L	VK
AP7365-33	SOT89-3L	VM
AP7365-39	SOT89-3L	VN
AP7365-08	SOT89R-3L	TB
AP7365-10	SOT89R-3L	TC
AP7365-12	SOT89R-3L	TD
AP7365-15	SOT89R-3L	TE
AP7365-18	SOT89R-3L	TF
AP7365-20	SOT89R-3L	TG
AP7365-25	SOT89R-3L	TH
AP7365-28	SOT89R-3L	TJ
AP7365-30	SOT89R-3L	TK
AP7365-33	SOT89R-3L	TM
AP7365-39	SOT89R-3L	TN

Marking Information (Continued)

(4) SOT223-3L

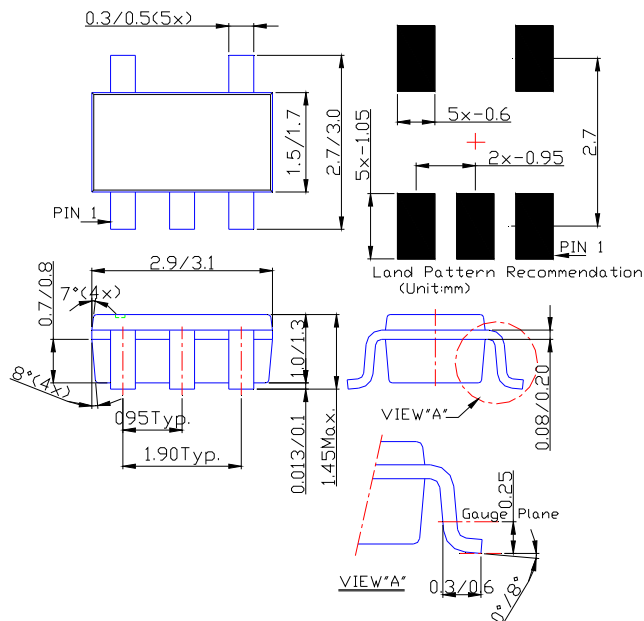


(5) SOT223R-3L

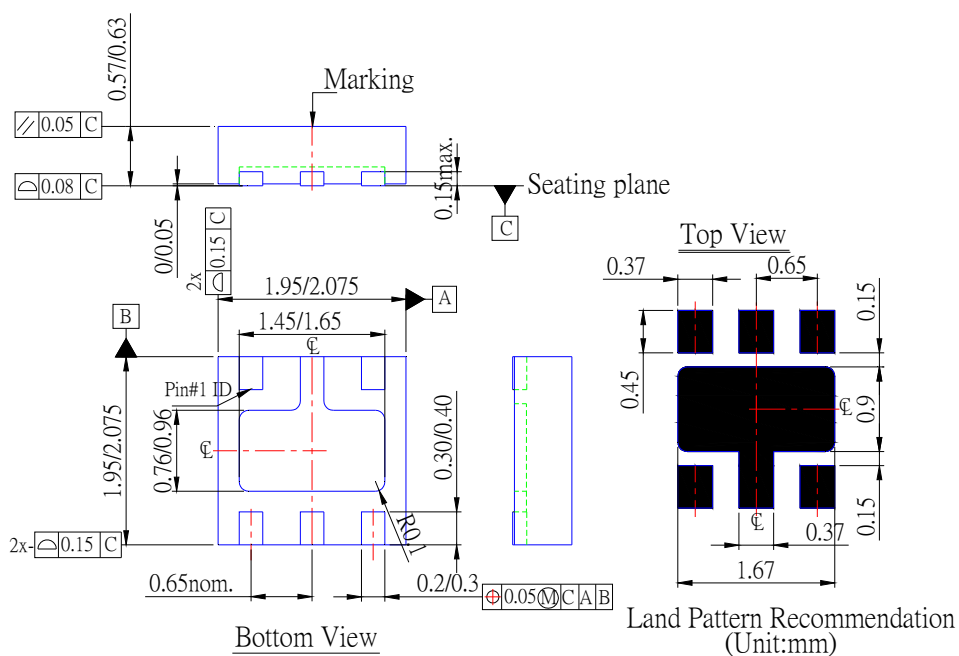


Package Outline Dimensions (Continued)

(1) Package Type: SOT25

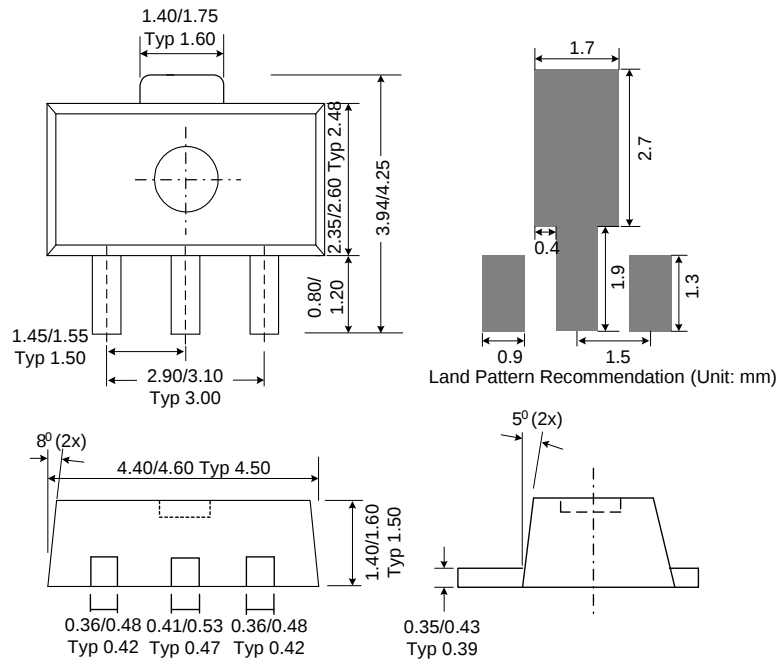


(2) Package Type: DFN2020-6

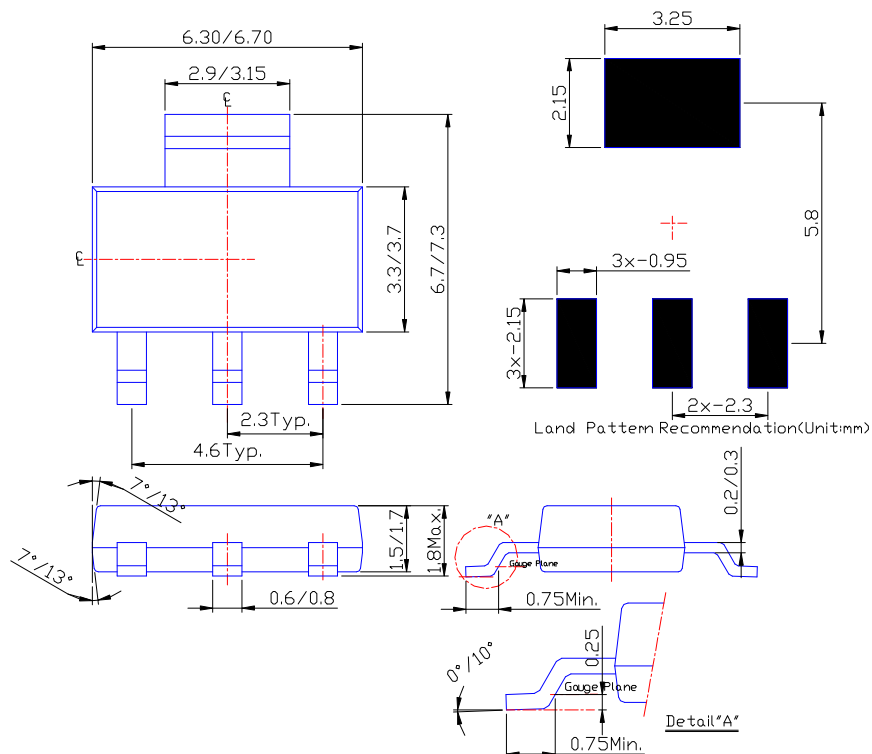


Package Outline Dimensions (Continued)

(3) Package Type: SOT89-3L and SOT89R-3L

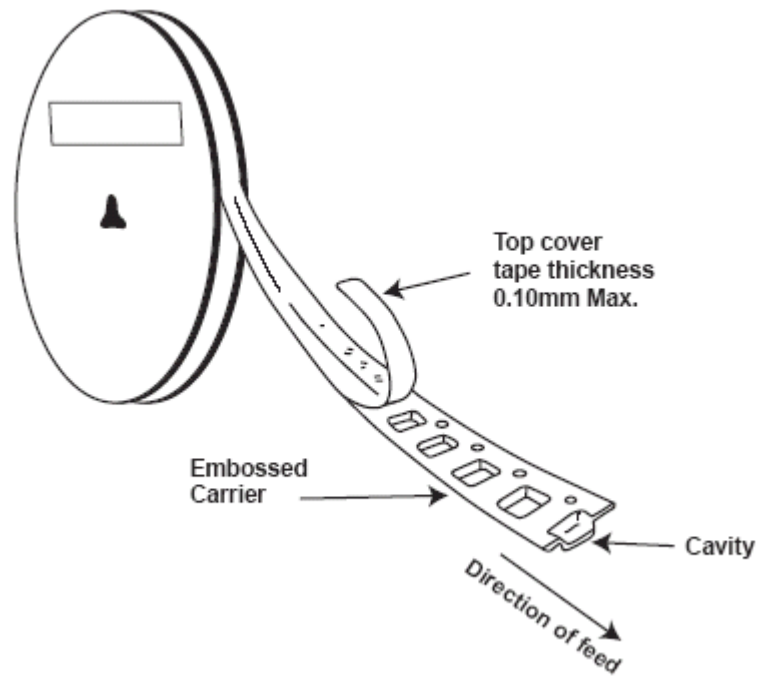
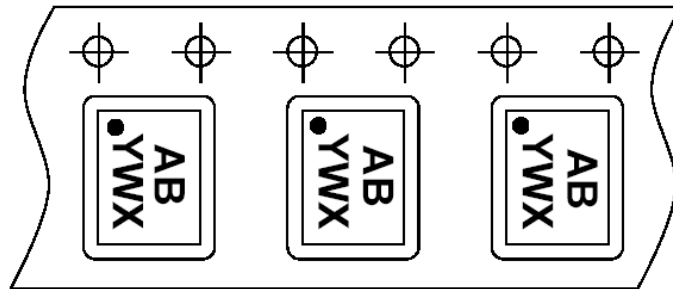


(4) Package Type: SOT223-3L and SOT223R-3L



Taping Orientation (Note 8)

For DFN2020-6



Notes: 8. The taping orientation of the other package type can be found on our website at <http://www.diodes.com/datasheets/ap02007.pdf>.

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